

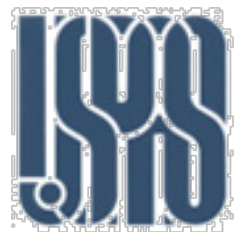
Vacuum Science and Technology for Accelerator Vacuum Systems

*Yulin Li and Xianghong Liu
Cornell University, Ithaca, NY*

UCDAVIS



Cornell Laboratory
for Accelerator-based Sciences
and Education (CLASSE)



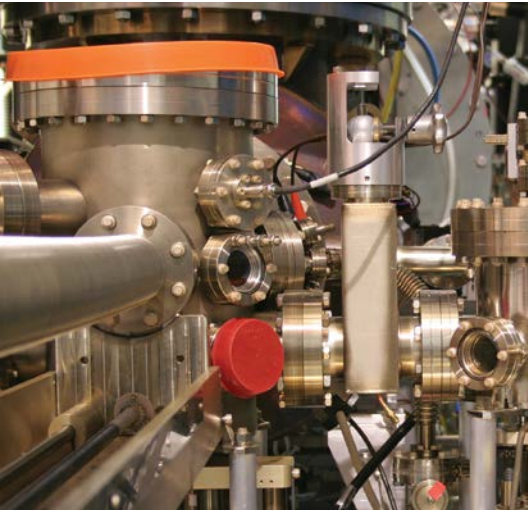


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- Vacuum Fundamentals
- Sources of Gases
- Vacuum Instrumentation
- **Vacuum Pumps**
 - Vacuum Components/Hardware
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SESSION 4.2-4.4: CAPTURE PUMPS

- *As named, these types of pumps operate by capturing gas molecules and binding them to a surface.*
- *The captured gases may be chemically bonded (chemisorbed), condensed (physisorbed), and/or buried.*
- *Capture pumps are naturally very clean. There are no moving parts, thus no lubrications, no noises. (But there may be particulates!)*
- *Most capture pumps have finite pumping capacity. After reaching the capacity, a pump has to be regenerated, or/and replaced. As such, a vacuum system needs to be 'roughed' down before a capture pump become functional.*
- *A good reference: Kimo M. Welch, "Capture Pumping Technology", 2nd Ed. Elsevier, North-Holland, 2006*

Capture Pumping – Category



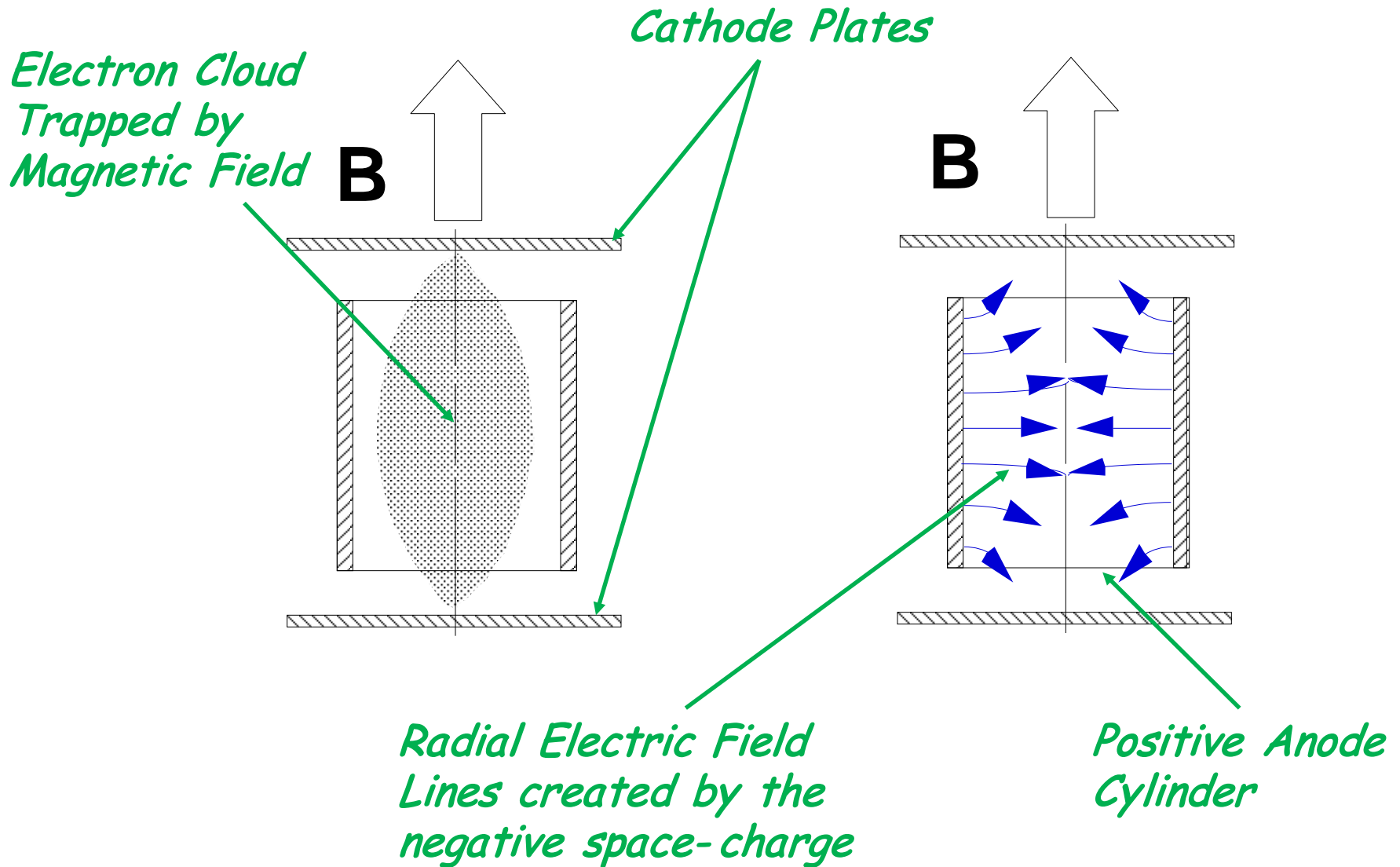
	Pumps	Properties
Active Pumping	Sputtering Ion Pumps	<ol style="list-style-type: none"> 1. Pump all gases, including noble gases 2. Working range: $10^{-5} \sim 10^{-11}$ torr 3. Very high lifetime capacity
Passive Pumping Physi-sorption	Sorption pumps	<ol style="list-style-type: none"> 1. Pump most air gases 2. Limited capacity 3. Working range: atm. $\sim 10^{-4}$ torr
	Cryo-pumps	<ol style="list-style-type: none"> 1. Pump all gases (except helium) 2. Working range: $10^{-5} \sim 10^{-11}$ torr 3. Very high capacity
Passive Pumping Chemi-sorption	Titanium sublimation pumps (TiSPs)	<ol style="list-style-type: none"> 1. Pump chemically active gases only 2. Working range: $10^{-6} \sim 10^{-11}$ torr 3. Capacity limited by Ti-covered surface area
	Non-evaporable getter pumps (NEGs)	<ol style="list-style-type: none"> 1. Pump chemically active gases only 2. Working range: $10^{-6} \sim 10^{-11}$ torr 3. Higher capacity than TiSPs, very high capacity for H_2.



SESSION 4.2: SPUTTER-ION PUMPS

- *Sputter-ion pumps were first commercialized by Varian Associates (now Agilent Technologies, Vacuum Division) as Vaclon pumps*
- *Ion pumps are made of a cluster of Penning cells, thus the pumping speed scales with number of cells.*
- *Advantages of ion pumps:*
 - *Very clean (UHV or chemically speaking)*
 - *Wide working pressure range, and for all gases*
 - *(Almost) unlimited pumping capacity*
- *Some concerns of ion pumps:*
 - *May generate particulates (metallic particles from cathodes)*
 - *Stray magnetic field may affect low energy particle beams*
 - *Space and weight*
 - *Radiation hardness of HV cables and controllers*

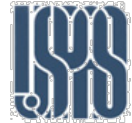
Penning Cell and Penning Discharge



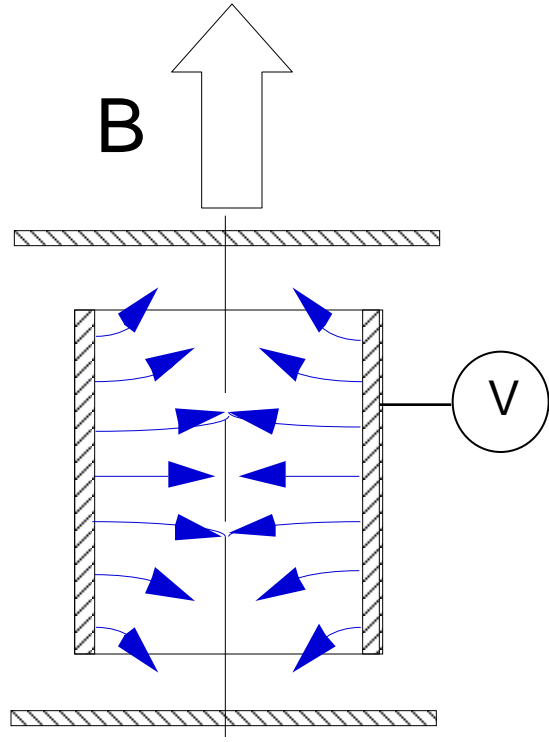
$$S = \frac{I^+}{P^n}$$

Where I^+ = ion current (Amps)
 P = pressure (Torr)
 $n = 1.05 \sim 1.50$

Parameters Affecting Penning Cell Sensitivity



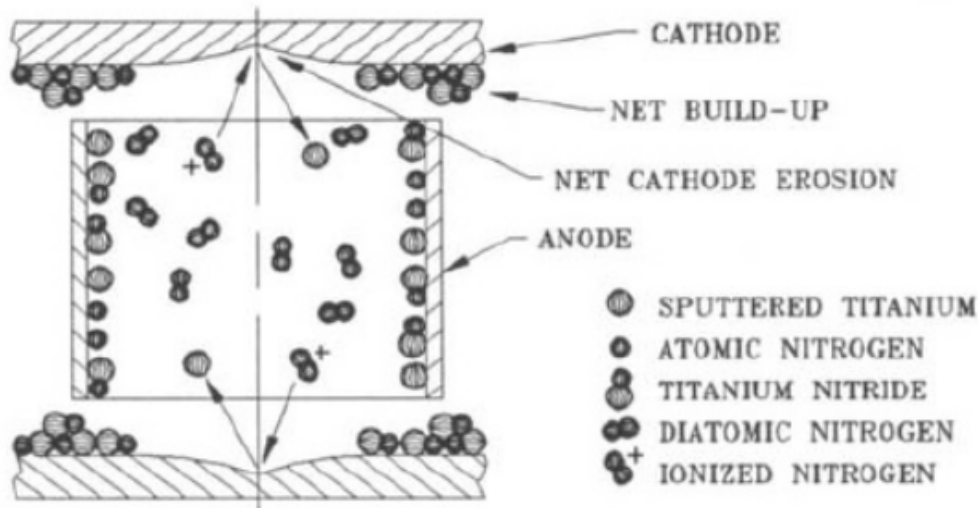
Anode Voltage	V	3.0 - 7.0 kV
Magnetic Field	B	0.1 - 0.2 T
Cell Diameter	d	1.0 - 3.0 cm
Cell Length	l	1.0 - 3.2 cm
Anode-Cathode Gap	a	0.6 - 1.0 cm



SIP Pumping Mechanism – General



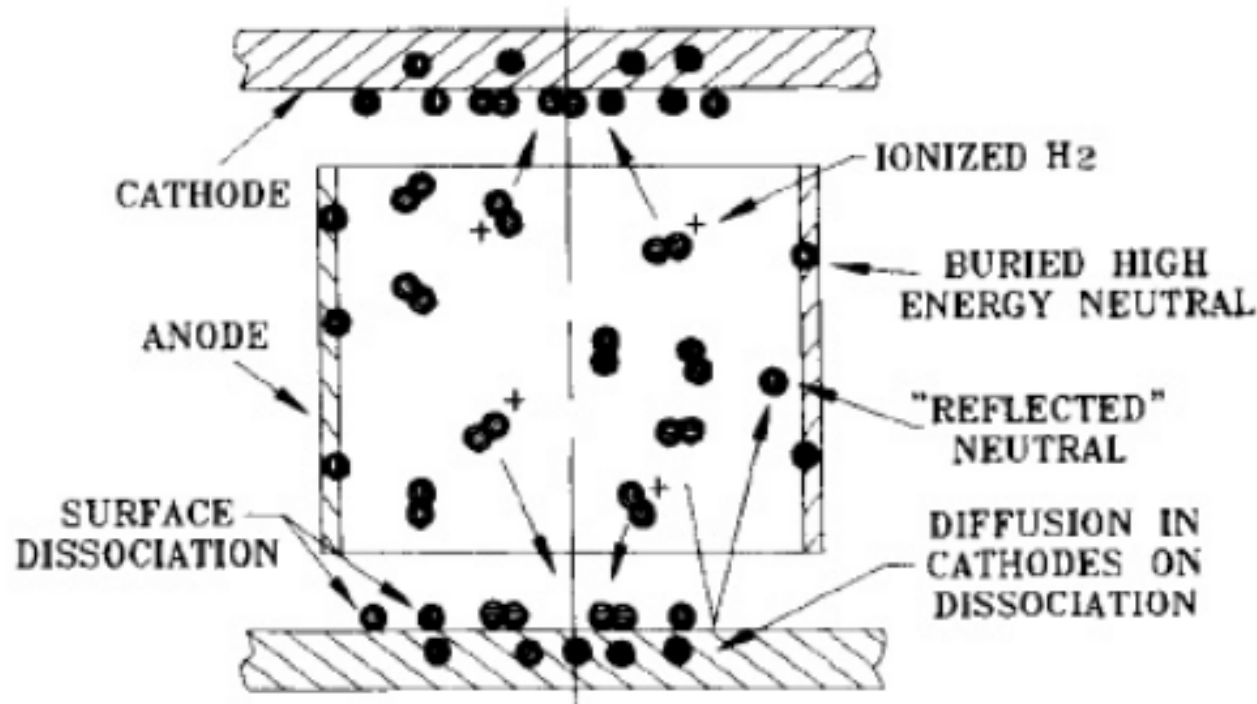
- ❑ An electron 'cloud' build up inside anode cell in the cross-field. The electron cloud may be started with field-emitted electrons, photo-electrons or radiations.
- ❑ The electrons gain kinetic energy in orbiting trajectories, ionize gas molecules by impact.
- ❑ While electrons from ionization contribute to the e-cloud, ions are accelerated towards cathode plates, and sputter off cathode materials.



- Gas molecules may be bonded to the 'fresh' cathode material, that is, **chemi-sorption**
- Or may be buried by the sputtered cathode atoms, that is, physical **embedding**. This is the main pumping mechanism for noble gases.



SIP Pumping Mechanism – Hydrogen



*Sputtering Ion Pumps pump hydrogen gas differently.
Hydrogen pumping is a two-step process:*

- *Hydrogen molecules dissociatively chemisorb on fresh metallic cathode surface*
- *Adsorbed H atoms then diffuse into the bulk of the cathodes*



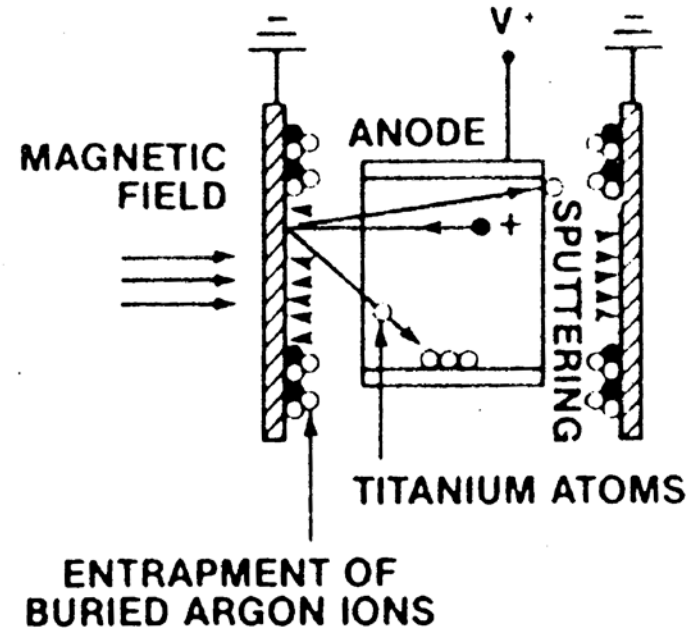
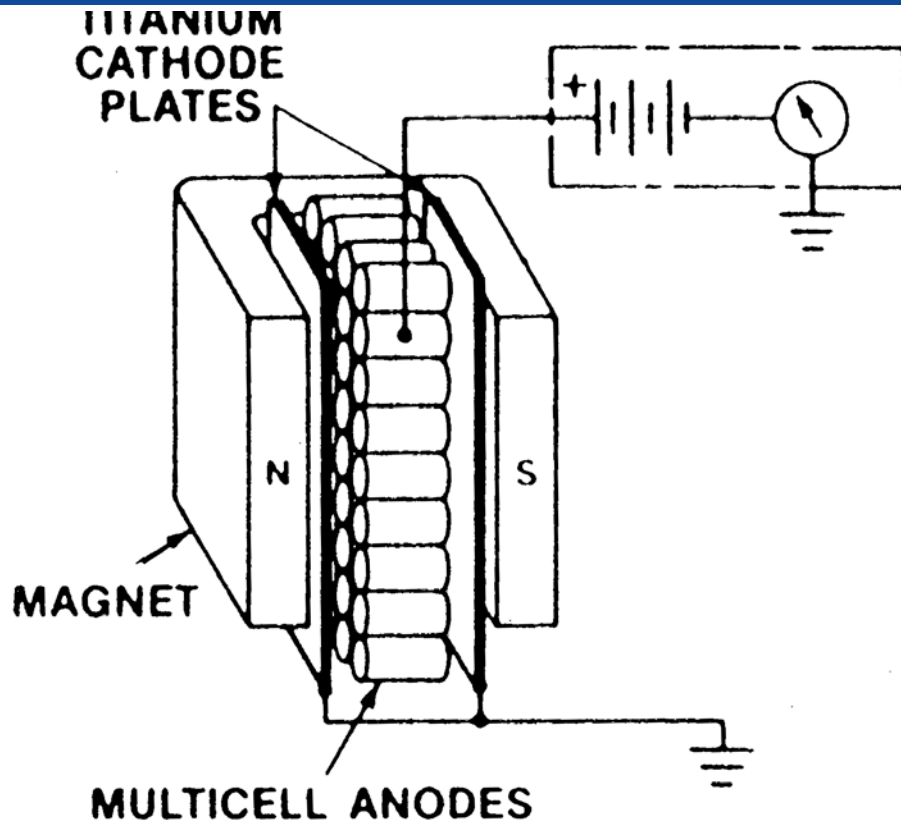
Types of Ion Pumps



- *Diode* - Most commonly used. Best for UHV systems where 98% of the gas is hydrogen. Diodes have the highest hydrogen pumping speed.
- *Differential (Noble Diode)* - Optimized for pumping noble gases, with a compromise for hydrogen pumping speed. This pump has reduced hydrogen pumping speed.
- *Triode/Starcell* - good hydrogen pumping speed, also pumps argon well. Good choice for pumping down from higher pressures often.



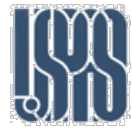
Diode sputter-ion pump



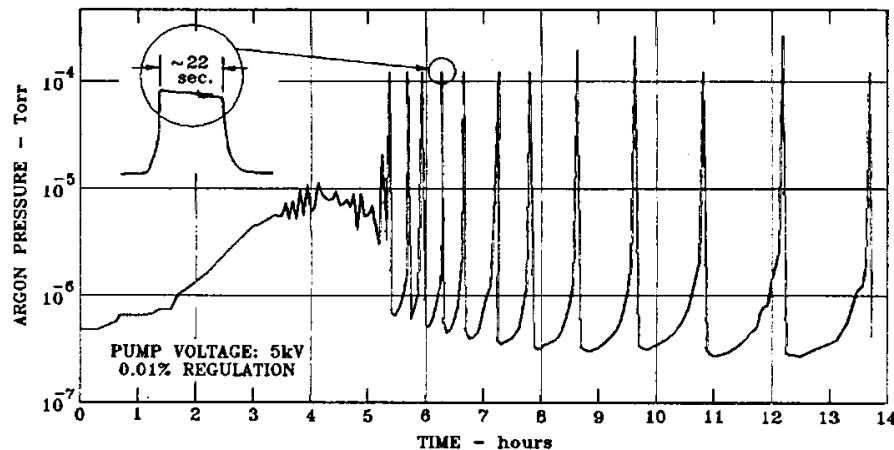
In a diode ion pump, both cathode plates are commonly made of titanium, due to its high sputtering yields and chemical reactivity



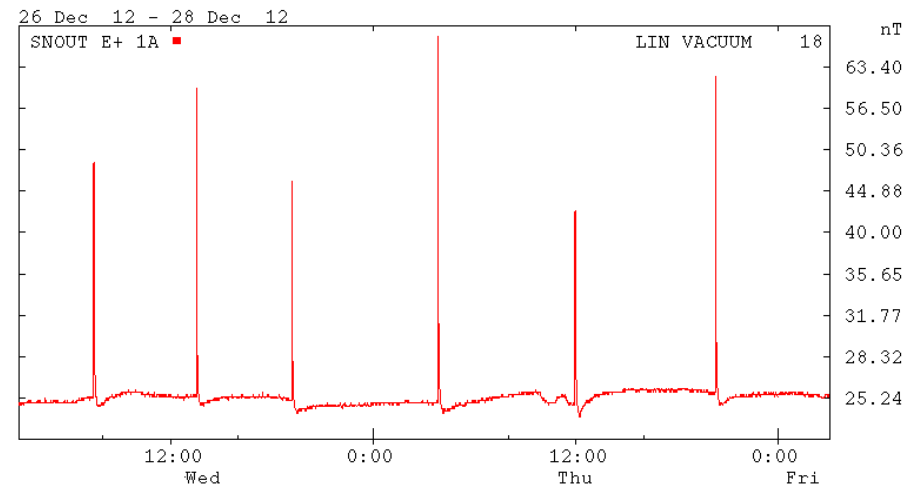
Argon Instability of Diode Ion Pump



- ❑ Periodic pressure bursts observed for diode ion pump while pumping air or gas mixtures containing inert gases.
- ❑ This phenomena is usually referred as "argon instability", and the burst gas is mostly Ar.
- ❑ The sources of the argon bursts are believed from buried argon (or other noble gases) in the cathode, and then release by sputtering processes.



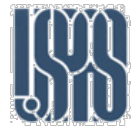
SLAC Ar-bursts



CESR LINAC Ar-bursts



Differential Ion (Noble Diode) Pumps

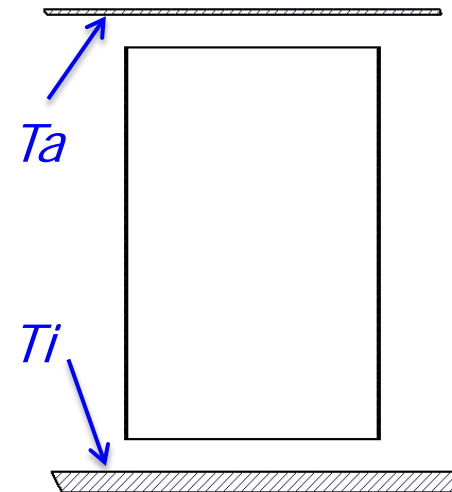
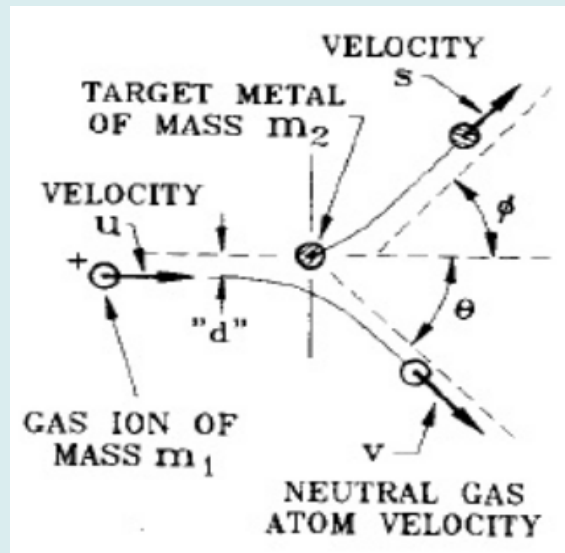


- ❑ In the so-called differential diode pumps, one of the Ti cathode plates is replaced with a heavy metal (commonly tantalum). The argon-instability is no longer an issue in the DI pumps.
- ❑ The enhanced noble gas pumping performance has been explained by a so-called fast neutral theory. The theory claims that the Ar^+ neutralized on cathode surface, and Ar scatters and buried in anode surface. When this occurs on heavier metals, Ar neutral maintains higher velocity, thus buried deeper.

Fast Neutral Theory

$$\frac{v}{u} = \frac{\cos \theta + (R^2 - \sin^2 \theta)^{1/2}}{R + 1}$$

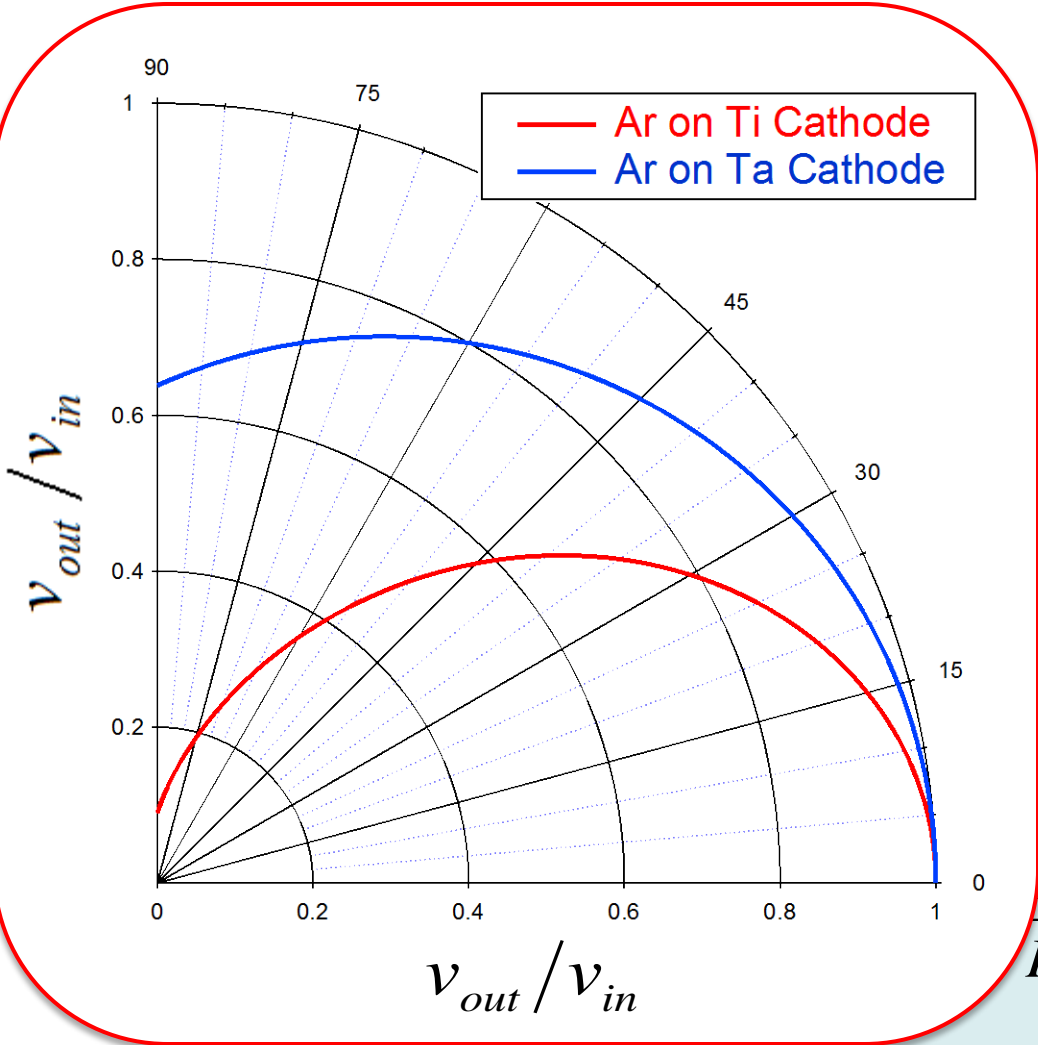
$$R \equiv m_2 / m_1$$



A D-I Cell



Neutral Ar Kinetic Energy - Ti vs. Ta Cathode

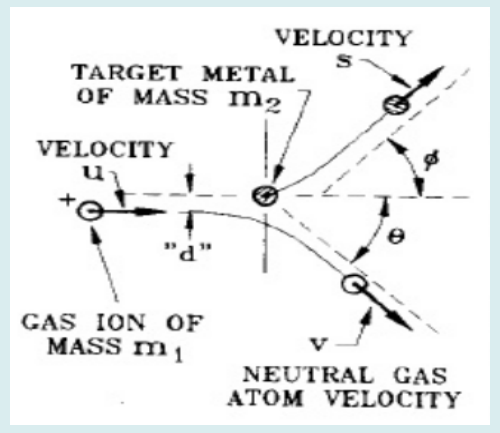


Argon neutrals clearly maintain much higher kinetic energy upon interaction with a Ta cathode as compared to with a Ti cathode

Scattering Theory

$$\frac{R^2 - \sin^2 \theta}{R + 1}$$

$$R \equiv m_2 / m_1$$



Noble Diode vs. Diode Pumps



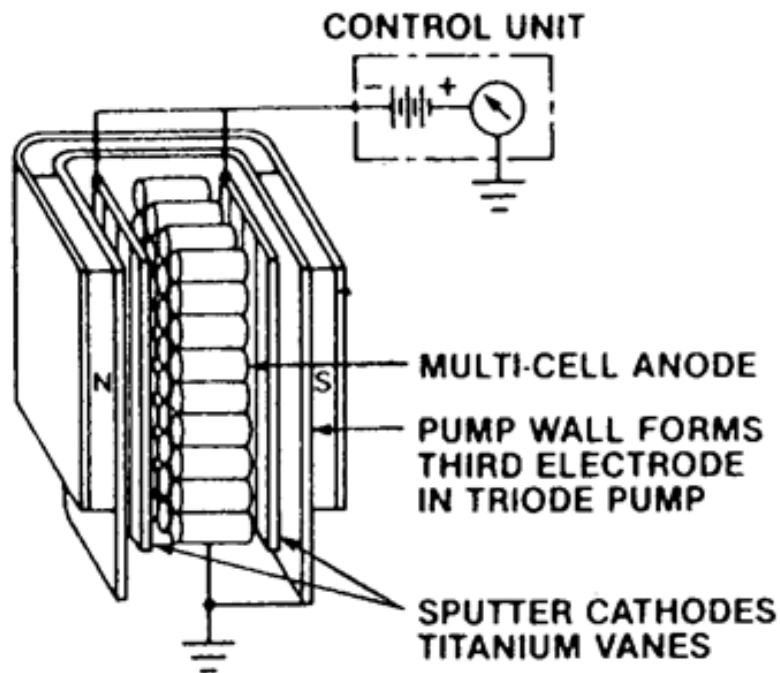
Gas	Noble Diode	Diode
H₂	160%	220%
CO₂	100%	100%
N₂	85%	85%
O₂	70%	70%
H₂O	100%	100%
Ar	20%	5%
He	15%	2%
Light Hydrocarbons	90%	90%



Triode Ion Pump

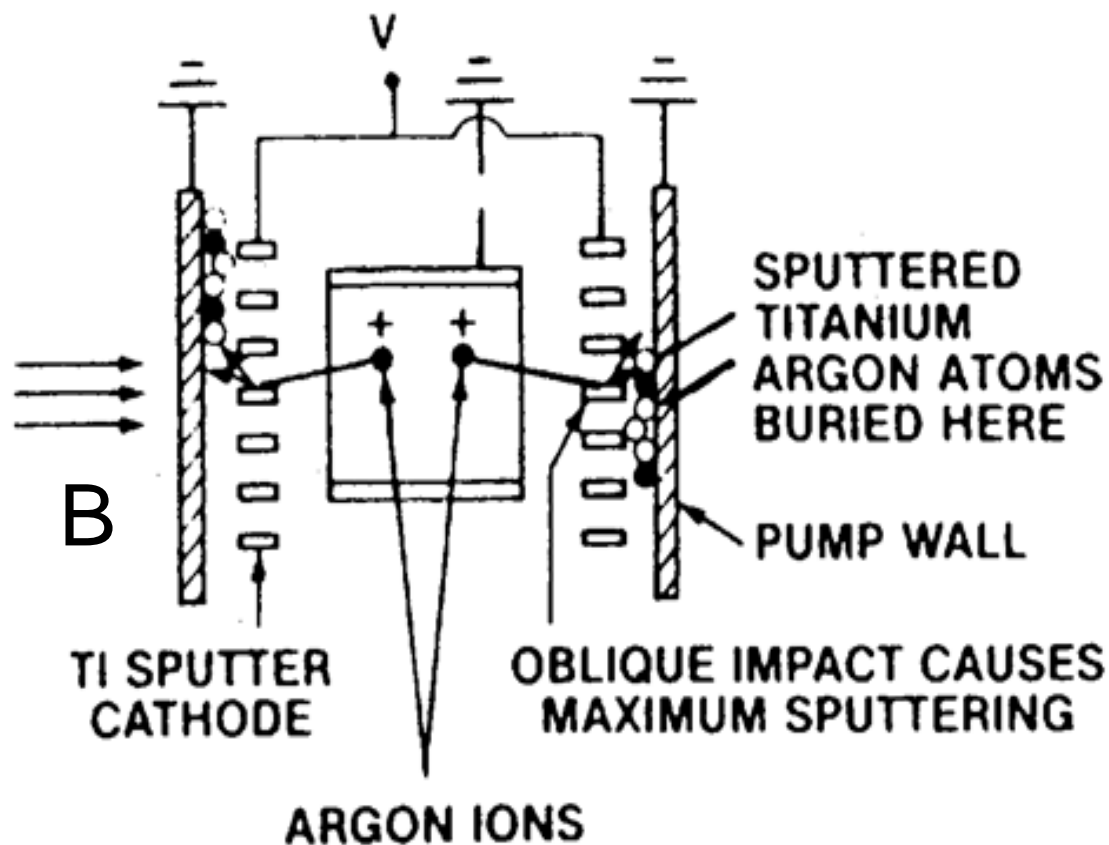


Another type of ion pumps handle noble gases well. Usually the triode pumping elements exchangeable with diode elements.

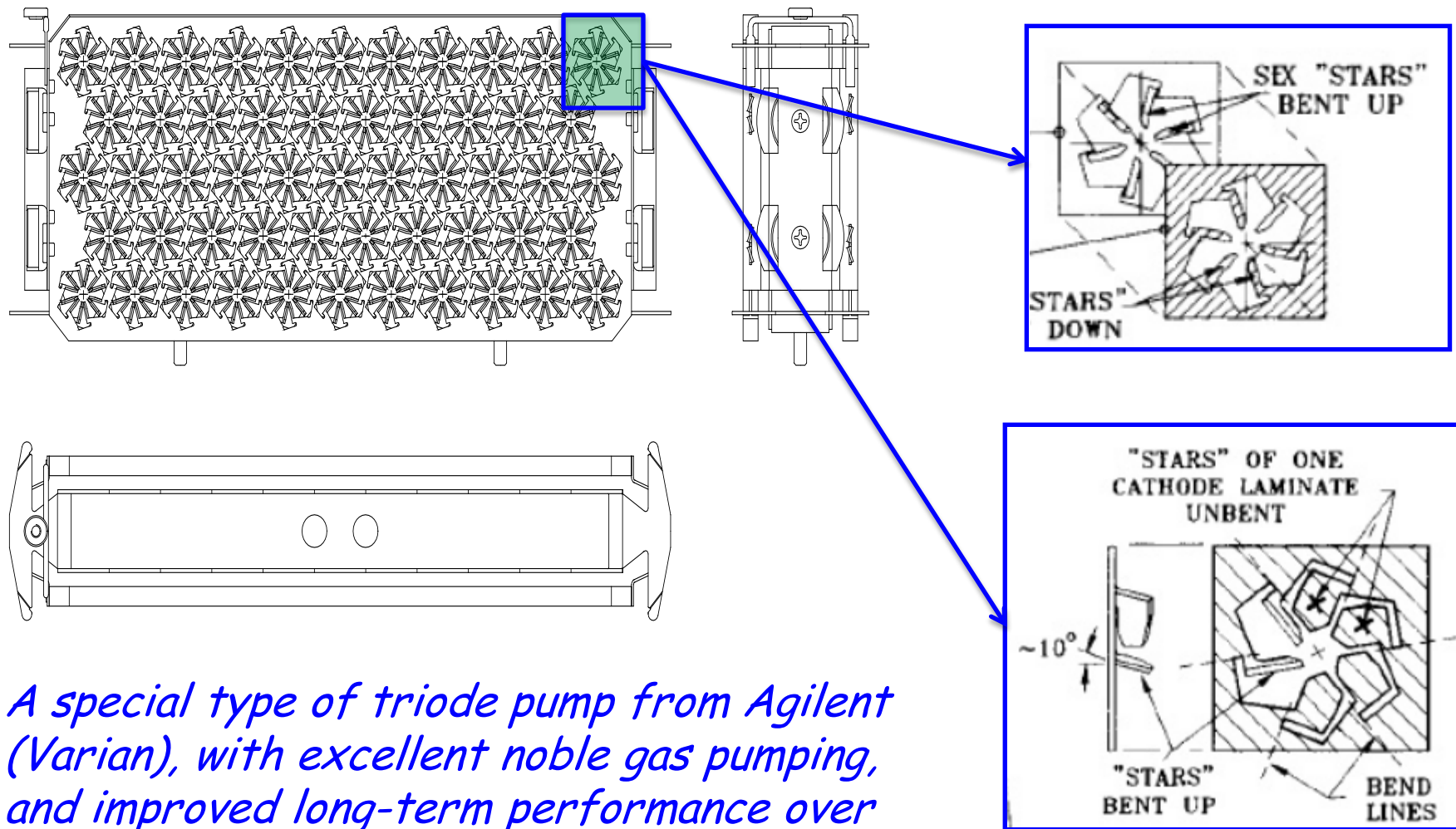


Disadvantages:

- ❖ Reduced pumping speed for all other gases.
- ❖ Expensive (due to complex assembling process)
- ❖ Cathode strips may cause short circuit.



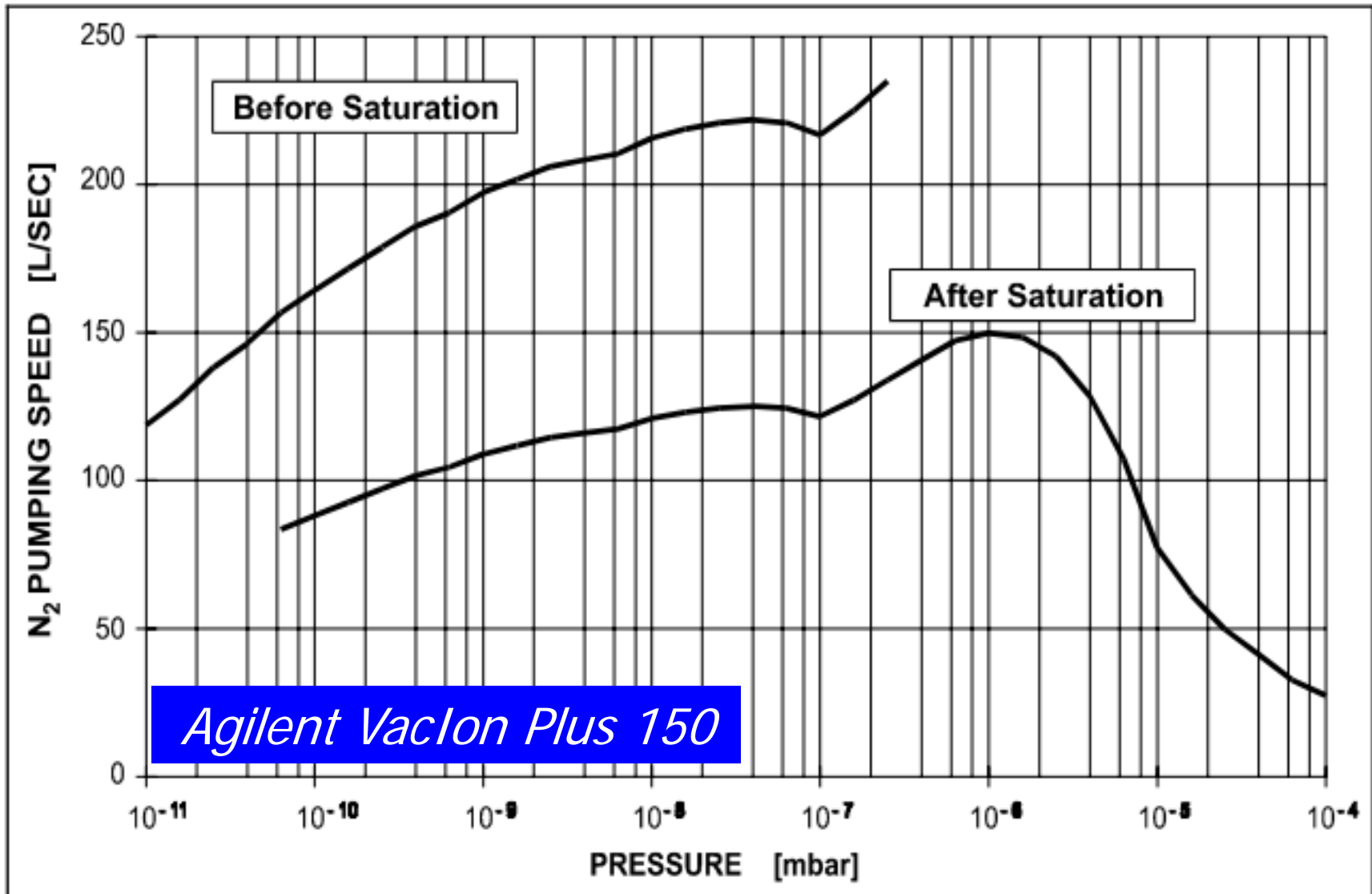
Triode Ion Pump – StarCell Pumps



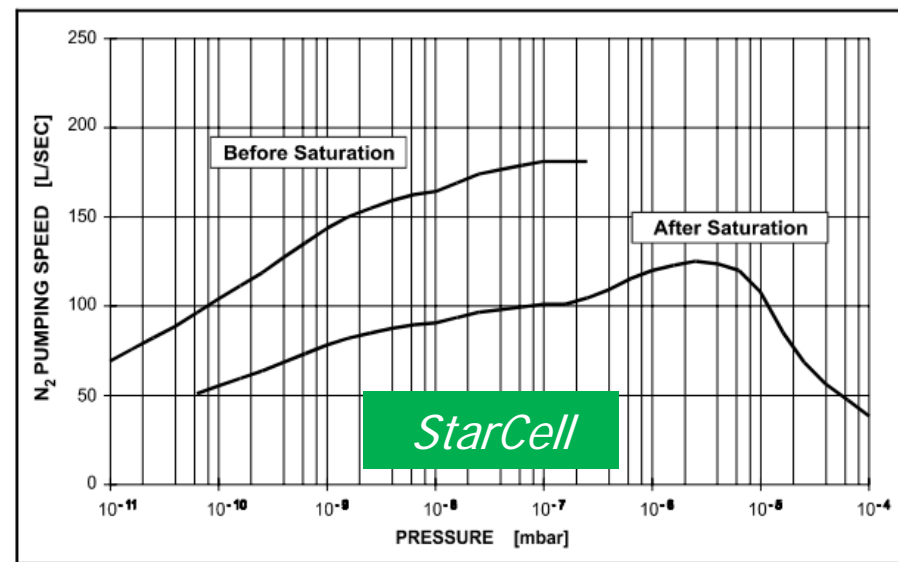
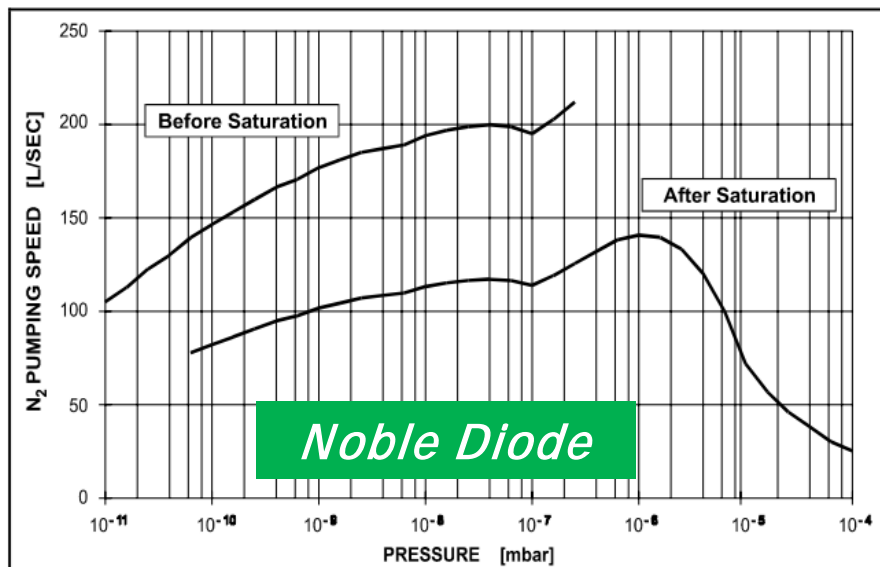
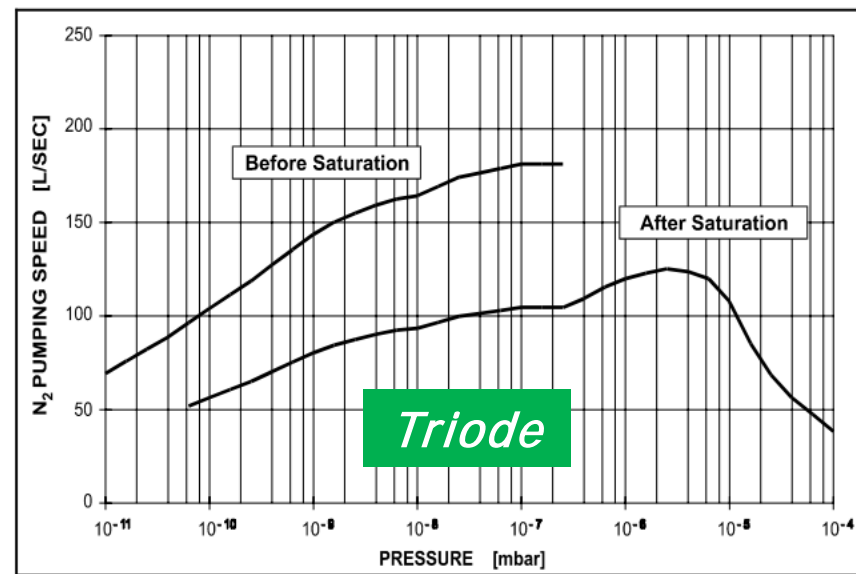
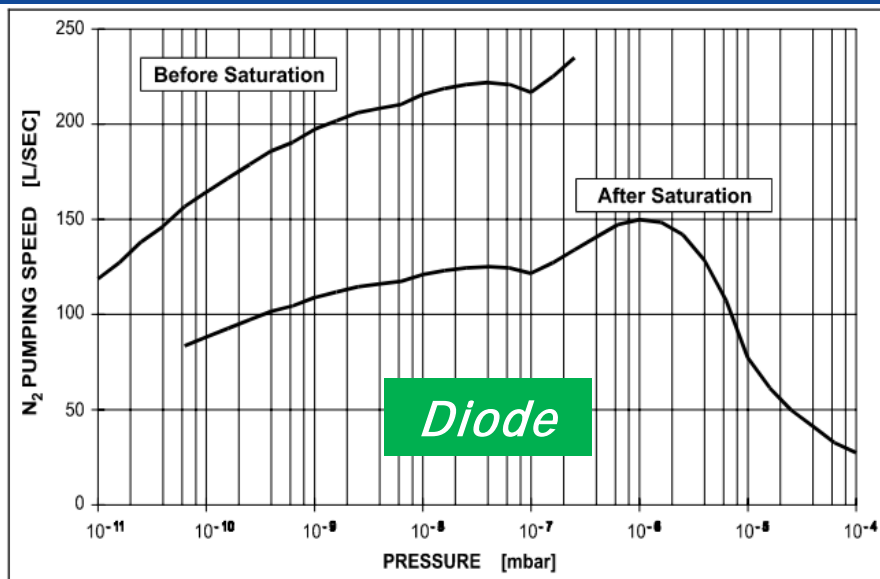
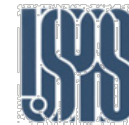
A special type of triode pump from Agilent (Varian), with excellent noble gas pumping, and improved long-term performance over strip-style triode pump.



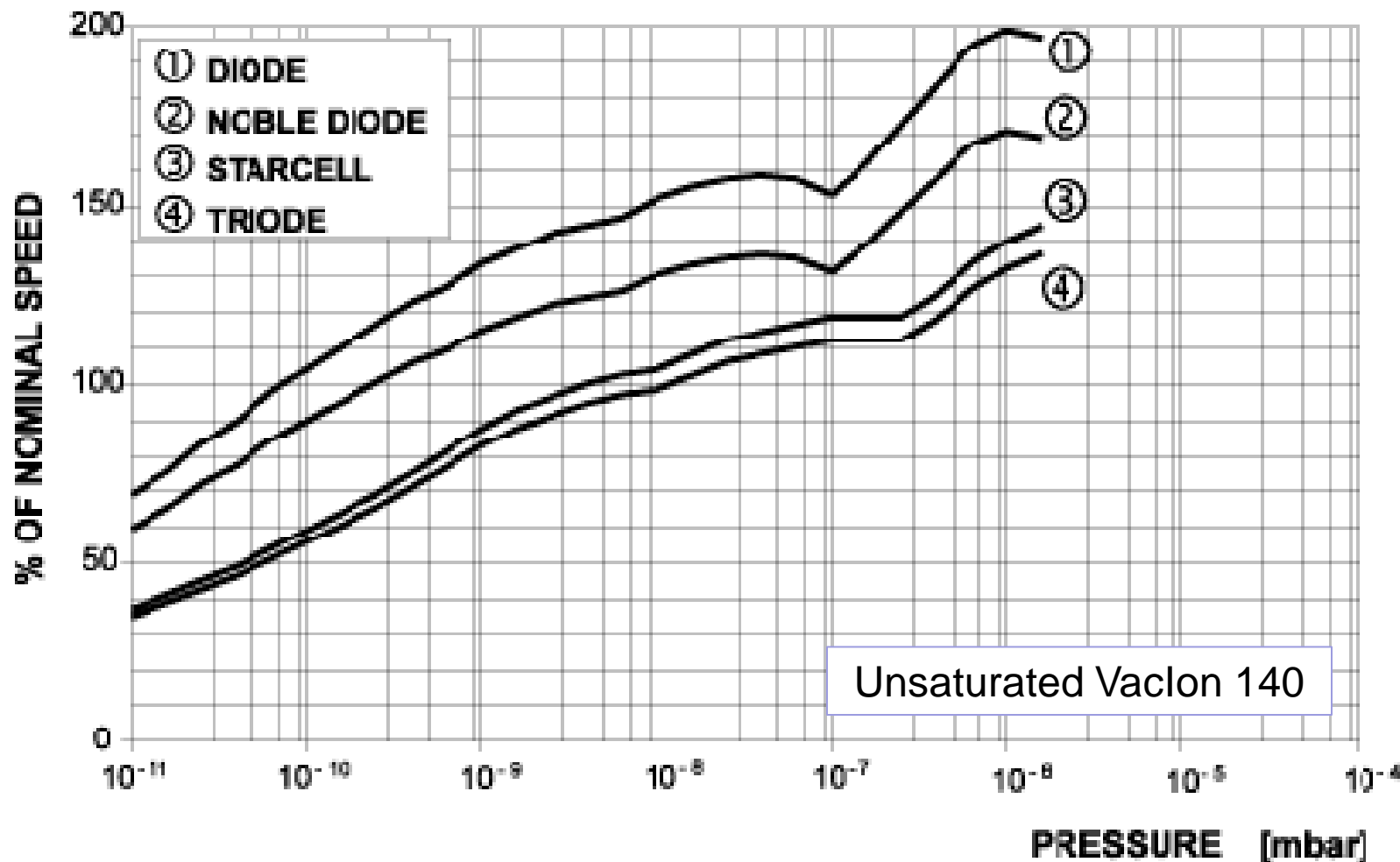
Diode Ion Pump – Pumping Speed



N_2 Pumping Speed of Different Styles



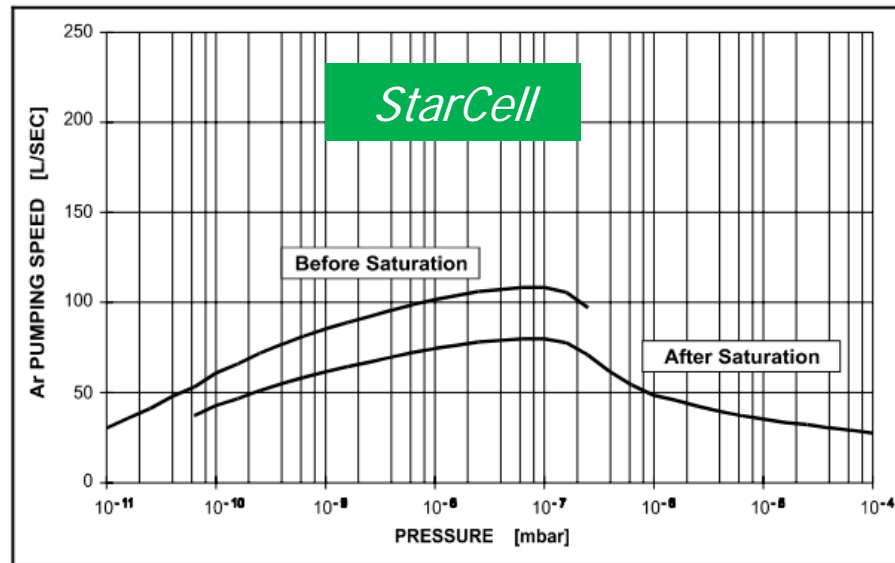
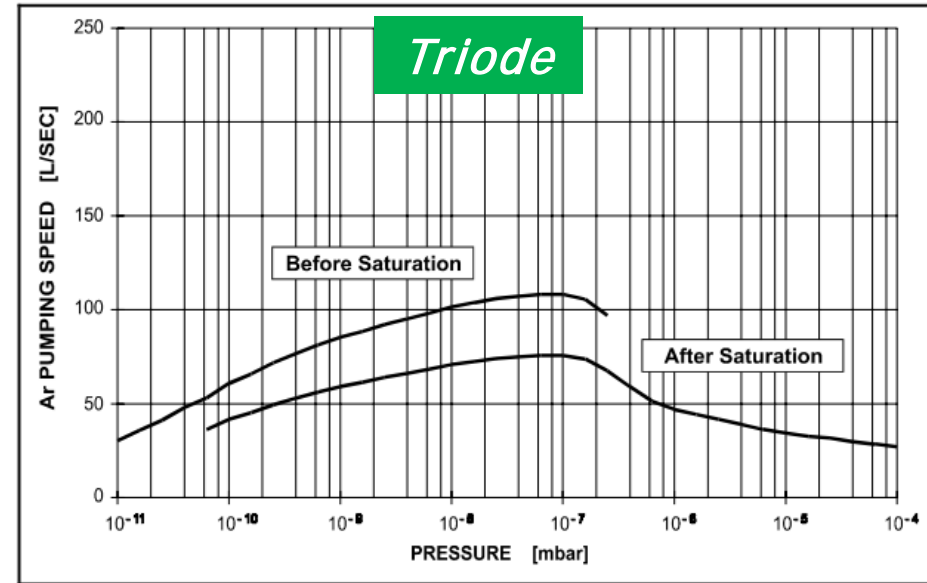
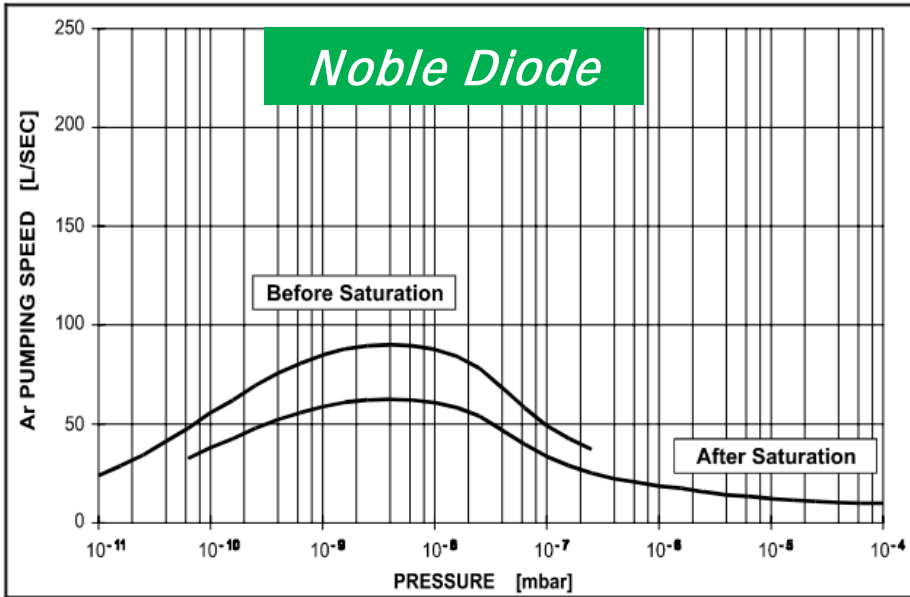
N_2 Pumping Speed of Different Styles



(Ref. Varian Vacuum)



Argon Pumping Speed of Different Styles



Ion Pump Performance for various gases



Gas	Diode	Noble Diode	Triode	Starcell	TSP	NEG
H ₂	3	1	1	2	3	4
He	1	3	3	4	0	0
H ₂ O	3	2	2	2	3	3
CH ₄	2	3	3	3	0	0
N ₂	3	3	2	2	3	3
O ₂ , CO, C O ₂	3	3	2	2	4	3
Ar	1	3	3	4	0	0

None	0
Poor	1
Good	2
Excellent	3
Outstand.	4

(Ref. Varian Vacuum)



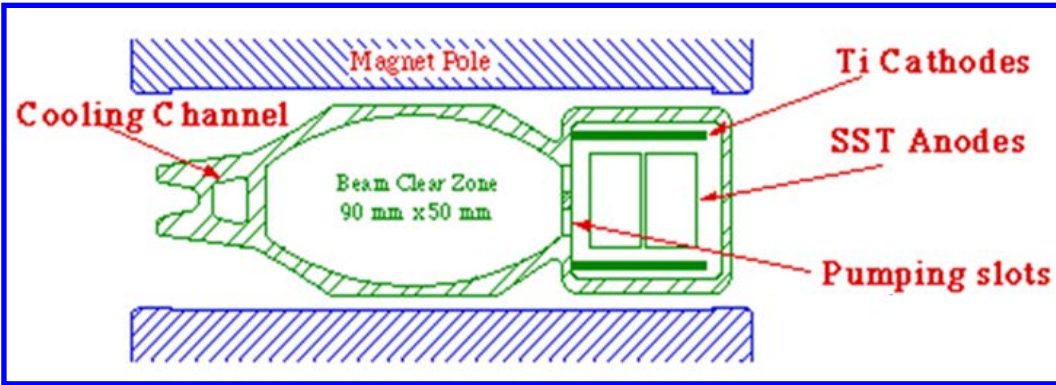


- *Brand-named: VacIon (old) and VacIon Plus*
- *Pump sizes from 2 l/s up to 500 l/s nominal speed*
- *Diode, noble-diode, triode and StarCell styles are available*
- *Combination with NEG available*

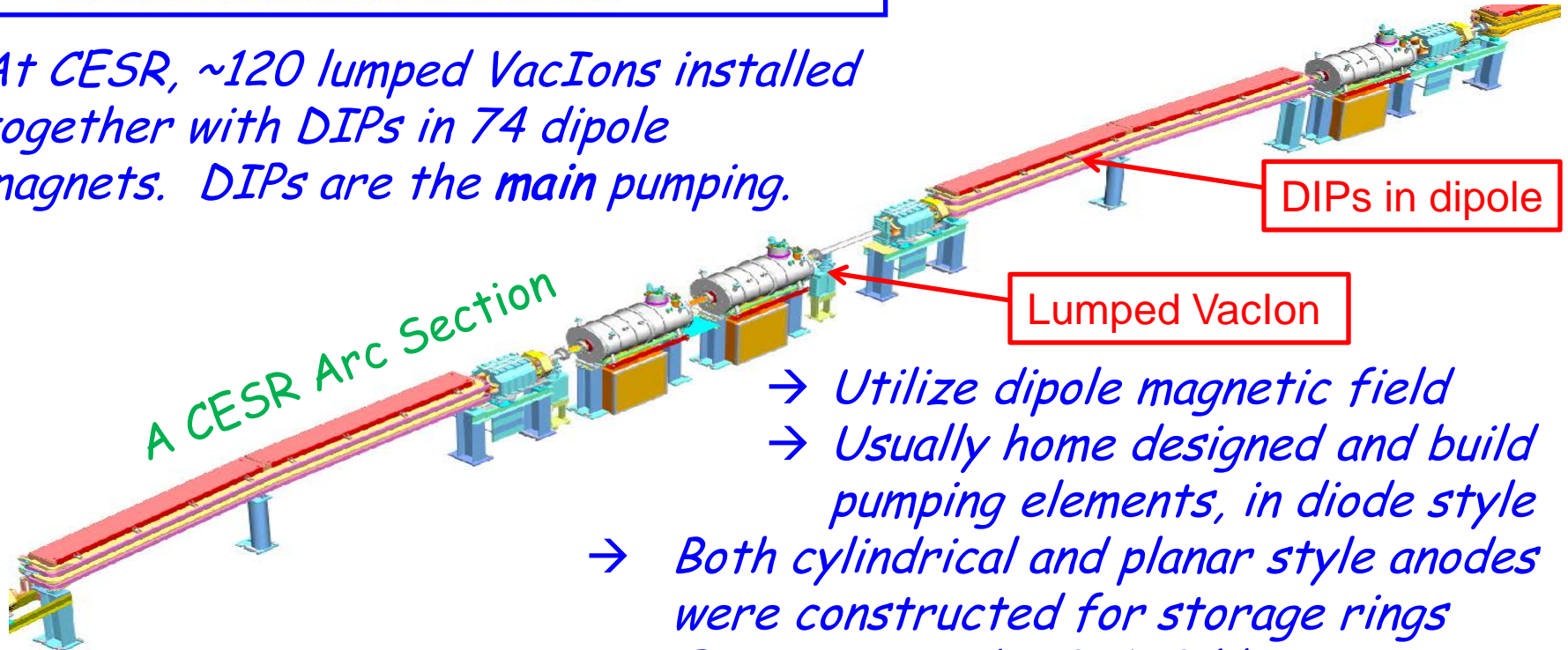


- Formerly Perkin-Elmer, brand-named: *TiTan Pumps*
- Pump sizes from 2 l/s up to 1600 l/s nominal speed
- Diode, noble-diode and triode styles are available
- Combination with NEG available

Distributed Ion Pumps (DIPs)



At CESR, ~120 lumped VacIons installed together with DIPs in 74 dipole magnets. DIPs are the main pumping.



- Utilize dipole magnetic field
- Usually home designed and build pumping elements, in diode style
- Both cylindrical and planar style anodes were constructed for storage rings
- Pumping speed: 80~120 l/s-m



Ion Pump Selection and Operation



- *For lumped ion pumps, noble gas pumping should be incorporated. Noble diode pumps are usually the best option, as the operating voltage polarity is same to regular diode pumps.*
- *In dipole magnet with sufficient field (> 0.1 T), DIPs are economical and reliable distributed pumping (as compared to NEG's).*
- *Extreme cares must be taken to protect HV electric feedthroughs of the ion pumps, both mechanically and environmentally (such as condensations and corrosions).*
- *For very long duration operations (30+ years in CESR), 'whiskers' may develop on anodes that cause partial shorting. These whiskers may be 'burnt' out by temporarily operating a pump at high pressure ($\sim 10^{-5}$ torr)*





- *Ion pump controllers provide DC high voltage needed for the ion pump operation.*
- *There are many suppliers for ion pump controllers. These are generally in two basic designs: the linear power controllers with transformers, and switchers. The formers are more robust, often with higher output power, but bulky and heavy. The switcher controllers are more commonly used nowadays.*
- *Important parameters in selection ion pump controllers:*
 - ✓ *Output power and current (ranging from < 1W to 100s W)*
 - ✓ *Pump ion current read-out precision (down to μA or even nA) and response time (for interlocking etc.)*
 - ✓ *Programmability and computer interface features*
 - ✓ *Radiation hardness*



Commercial Ion Pump Controllers



Switcher



Agilent 4 UHV

Output Power: 400 W
Output HV: 3, 5, 7 kV
Current: up to 200 mA
Ion Current: 10 nA ~ 100 mA

Switcher



Agilent MiniVac

Output Power: 20~40 W
Output HV: 5 kV
Current: up to 20 mA
Ion Current: 10 μ A~20 mA

Linear



Gamma Vacuum LPC

Output Power: 200 W
Output HV: 5.6/7.0 kV
Current: up to 100 mA
Ion Current res: 10 nA

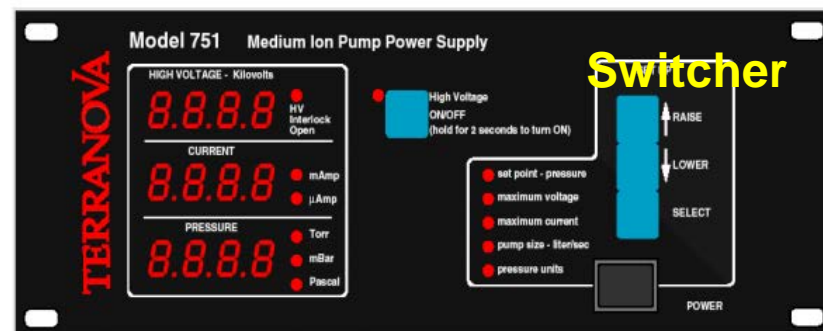
Switcher



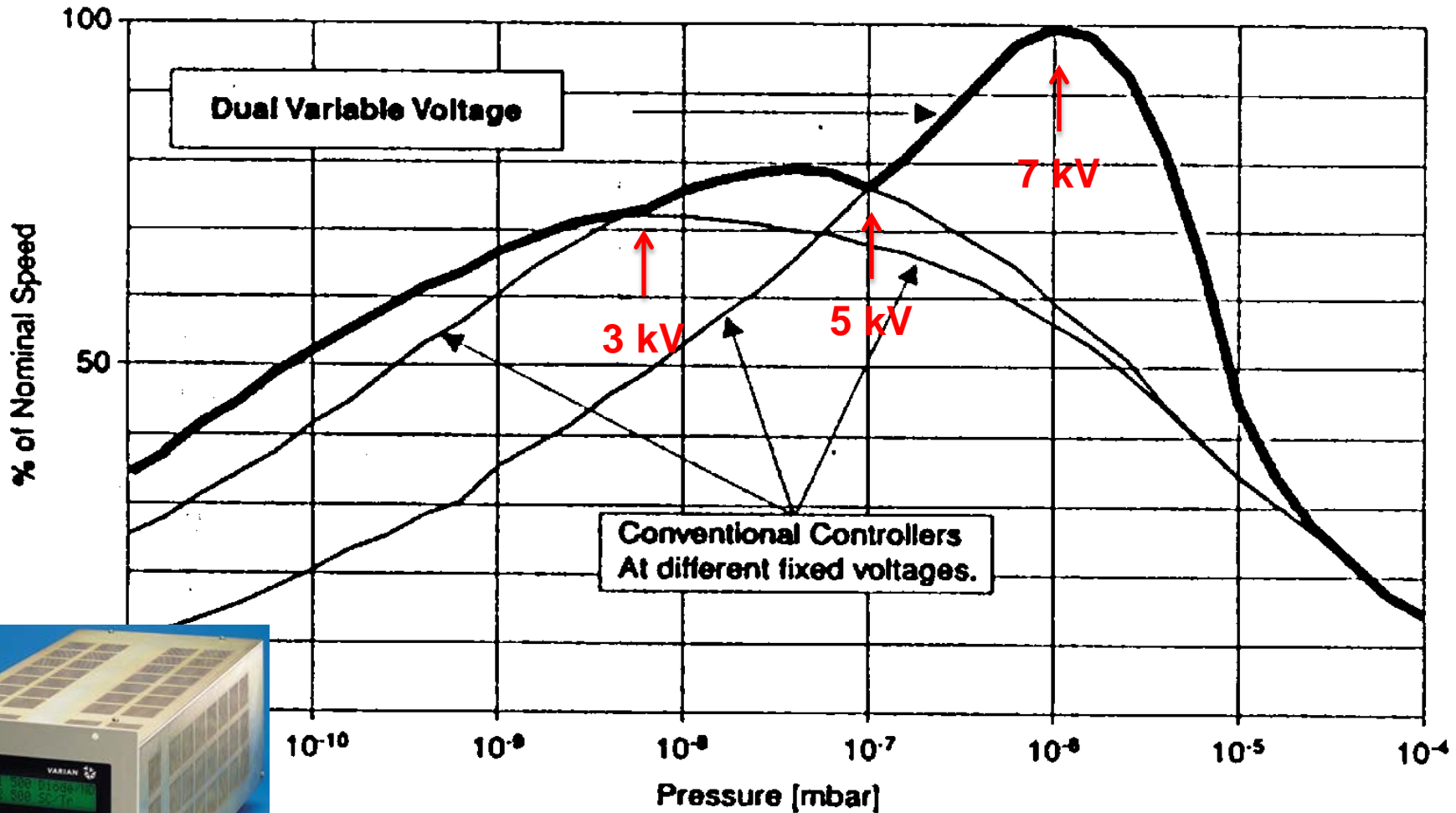
Gamma SPC

Output Power: 40 W
Output HV: 3.5~7.0 kV
Current: up to 50 mA
Ion Current res: 1 nA

Switcher



"Step-Voltage" May Improves Pump Performance



(Ref. Varian Vacuum)



Summary Notes



- 1) *Sputter-ion pumps are the primary UHV pumps for most modern accelerators, due to their cleanness and very high pumping capacity.*
- 2) *SIPs are most suitable at vacuum pressure $< 10^{-7}$ torr. At these low pressures, their most efficient pumps, drawing almost no power.*
- 3) *As a capture pump, SIP has limited lifetime capacity. At extreme cases, ions may drill holes through cathode plates, resulting much poor performance and pressure spikes.*
- 4) *Starting SIPs should be done by experts, who understand the risk of thermal run-away in the pumping elements, especially in triode pumps.*
- 5) *Aged SIPs tend to have reduced H_2 pumping speed, at UHV conditions. Thus combination with NEG is recommended.*
- 6) *Glow charge at high pressure may extend throughout a SIP, and potential metallic coating of sensitive surfaces may occur.*

